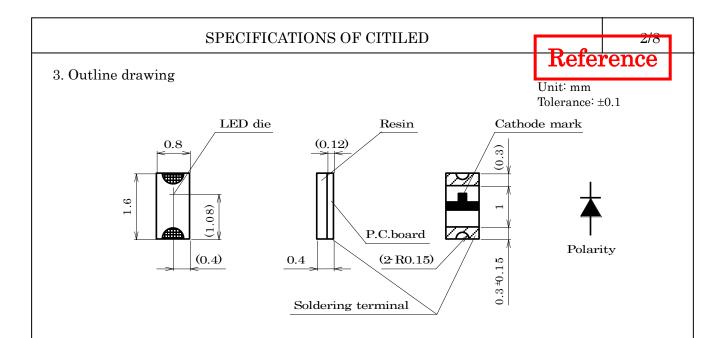
SPECIFICATIONS OF CITILED							1/8
							rence
1. Scope of App These specif	fication fication fications apply to chi	p type LED	lamp, CIT	ILED, mod	lel CL-197		
2. Part code							
		$\mathbf{C}\mathbf{T} = 1$	07 1			т	
			<u>.97 H</u>			<u>₽</u> _	
Lig Col Diff	ies 197 : Mono-color Ultra small, the hting color HG5 : High brightne or of lens C: Colored fusion D : Diffused pping mode Non-coded: Bulk T: Taping (standard)	in type ess green					
		Approved	Checked	Drawn	Symbol		CITILED
					Name	CL-19	7HG5
					Drawing No		
Mark Date I	Description Appro.		CITIZI	EN ELECTR	I CONICS CO.	LTD.	



4. Performance

(1) Absolute Maximum Rating

			(Ta=25°C
Parameter	Symbol	Rating Value	Unit
Power Dissipation	Pd	76	mW
Forward Current	$\mathbf{I}\mathbf{F}$	20	mA
Forward Pulse Current *	Ifp	100 *	mA
Reverse Voltage	$V_{\rm R}$	4	V
Operating Temperature	Тор	-25 ~ +80	°C
Storage Temperature	Tst	-30 ~ +85	°C

* Duty $\leq 1/10$, Pulse width ≤ 0.1 msec

(2) Electro-optical Characteristic

(Ta=25°C)

						1a-20 U
Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Forward Voltage	$V_{\rm F}$	IF=20mA	_	3.3	3.91	V
Reverse Current	Ir	$V_R=4V$	_		100	μA
Luminous Intensity *	Iv	IF=20mA	36.4	100	—	mcd
Dominant Wavelength	$\lambda_{ m d}$	IF=20mA	516		539	nm
Dominant Wavelength		IF=20mA	516		539	

* In accordance with NIST standard

Note 1) The tolerance of Forward Voltage measurement is $\pm 3\%$ at our tester.

Note 2) The tolerance of Luminous Intensity measurement is $\pm 10\%$ at our tester.

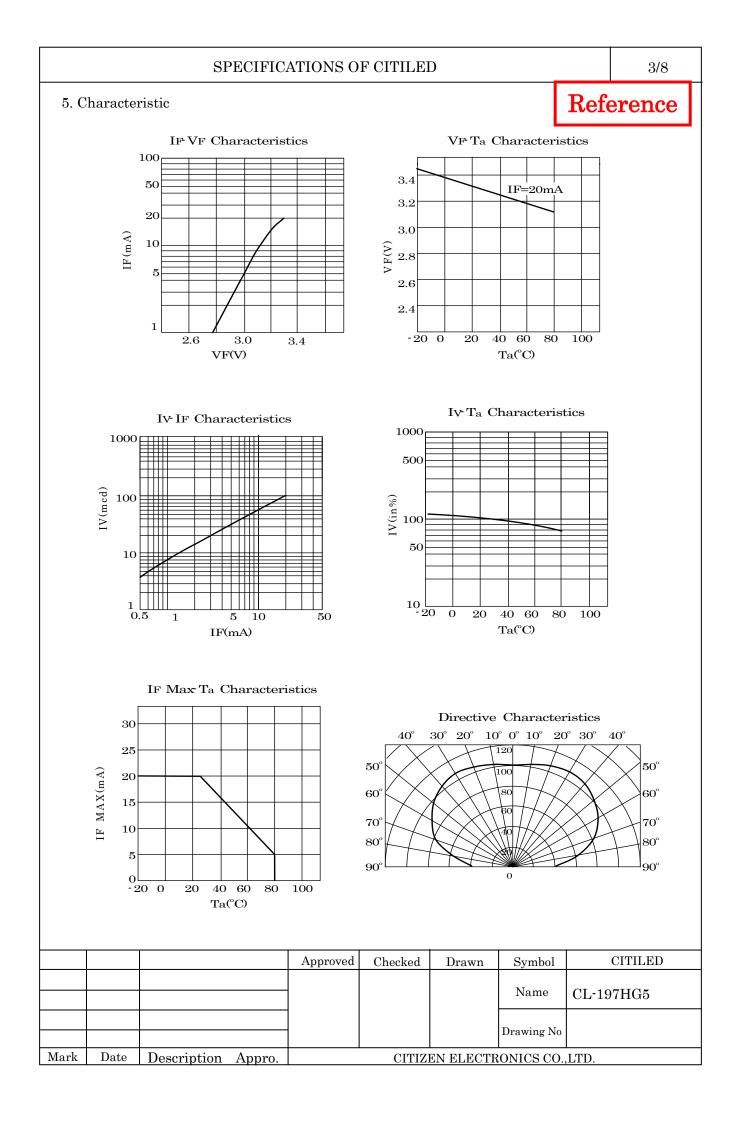
Note 3) The tolerance of Dominant Wavelength measurement is $\pm 2nm$ at our tester.

Note 4) For handling, please apply CMOS LSI or equivalent to prevent any electrostatic effect.

Note 5) Please be aware that the above electro-optical characteristics are guaranteed when applying the current values shown in the table.

Please consult us when this product is used under any other conditions.

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-197HG5
						Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				



SPECIFICATIONS OF CITILED

6. Reliability

Reference

(1) Details of the tests

Test Item	Test Condition
Life Test in Continuous Operation	25±3 °C, maximum rated value \times 500 $^{\scriptscriptstyle +24}_{\scriptscriptstyle -12}$ hours
Low Temperature Storage Test	-30_{-5}^{+3} °C × 500 $_{-12}^{+24}$ hours
High Temperature Storage Test	85^{+5}_{-3} °C × 500 $^{+24}_{-12}$ hours
Moisture-proof Test	$60 \pm 2^{\circ}$ C, $90 \pm 5\%$ RH for $500 \frac{+24}{-12}$ hours
Thermal Shock Test	$-30^{\circ}C \times 30$ minutes – $85^{\circ}C \times 30$ minutes, 5-cycle
Solder Heat Resistance Test	Recommended temperature profile (reflow soldering) \times 2, (2 nd test must be started after the samples are stabilized thermally.)

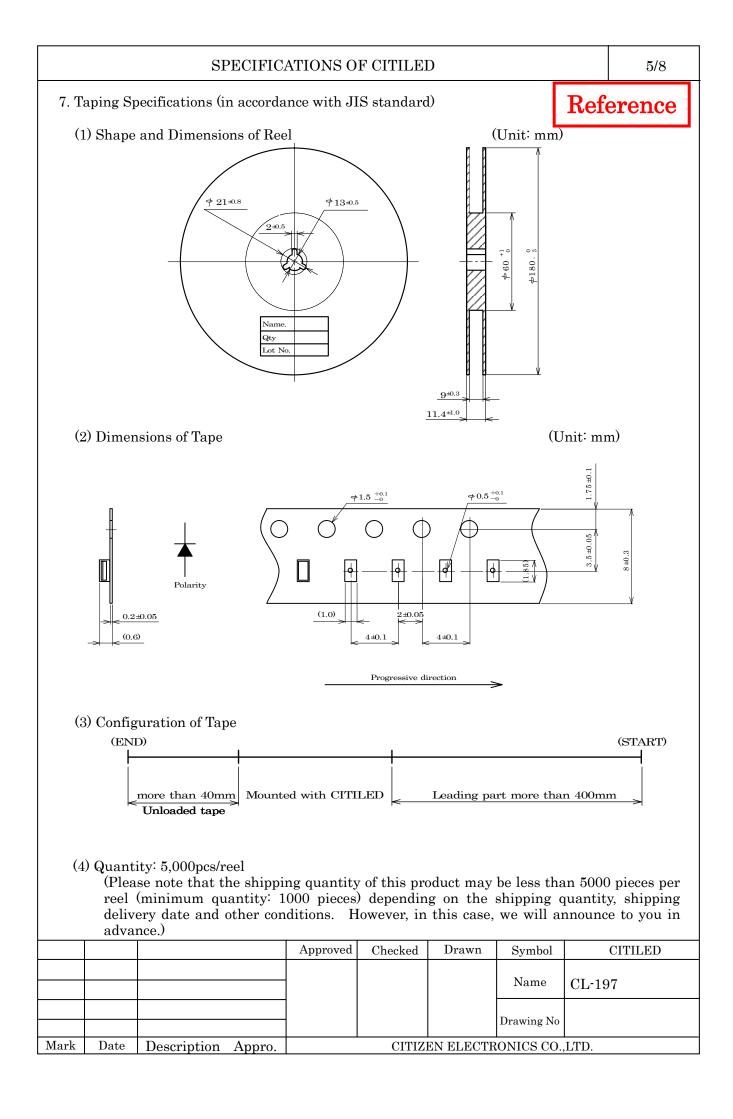
(2) Judgment Criteria of Failure for Reliability Test

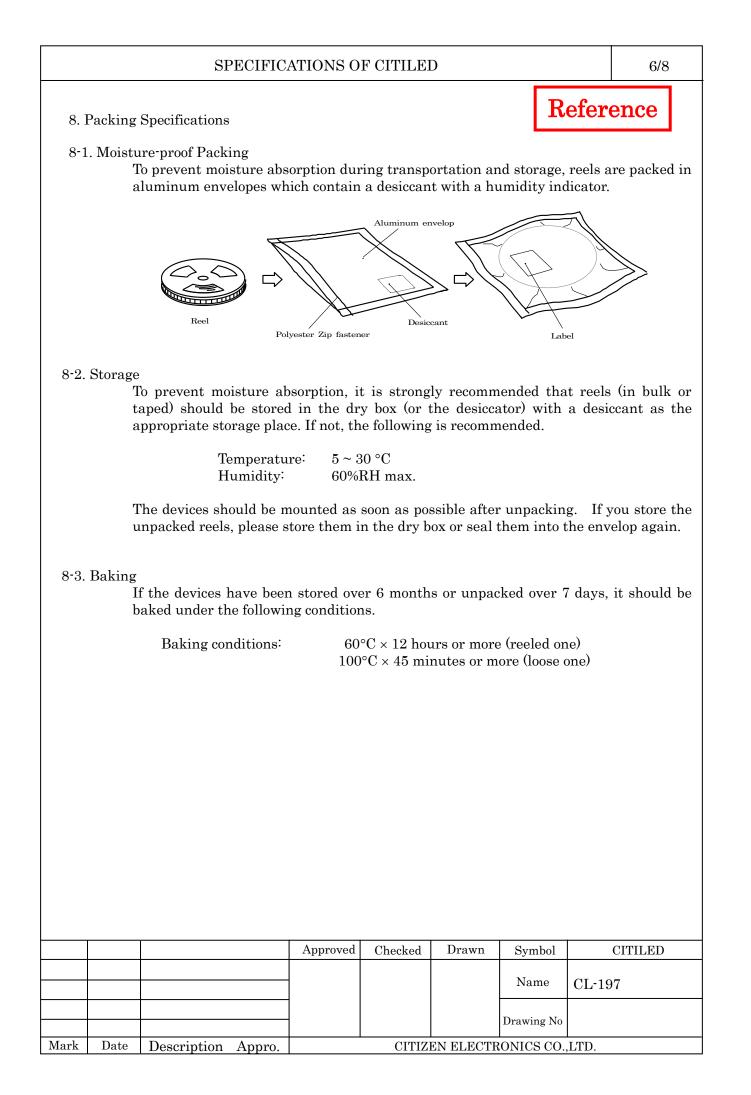
Measuring Item	Symbol	Measuring Condition	Judgement Criteria for Failure
Forward Voltage	$V_{\rm F}$	I _F =20mA	>U×1.2
Reverse Current	I_{R}	$V_R=4$ V	>U×2
Luminous Intensity	Iv	I _F =20mA	<s×0.5< td=""></s×0.5<>

U means the upper limit of the specified characteristics. S means the initial value.

Note: Measurement shall be taken between 2 hours and 24 hours, having returned the test pieces to the normal ambient conditions after the completion of each test.

			Approved	Checked	Drawn	Symbol	CITILED	
						Name	CL-197	
						Drawing No		
Mark	Date	Description App	<u>.</u>	CITIZEN ELECTRONICS CO.,LTD.				





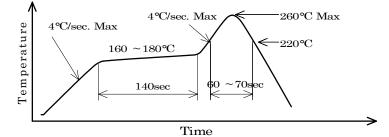
SPECIFICATIONS OF CITILED

9. Precautions

9-1. Soldering

(1) Manual soldering

- 1) Solder of 96.5Sn 3Ag 0.5Cu is recommended.
- 2) Before soldering every time, make baking to units. By manual soldering, it is the possibility of crack due to the moisture absorption in the resin portion.
- 3) Use a soldering iron of 25W or smaller. Adjust the temperature of the soldering iron below 350°C.
- 4) Force or stress must not be applied to the resin portion while soldering.
- 5) Finish soldering within 3 seconds.
- 6) Handle the devices only after temperature is cooled down.
- (2) Lead free soldering
 - 1) Following soldering paste is recommended Melting temperature: 216 ~ 220°C.
 - Composition: 96.5Sn 3Ag 0.5Cu
 - 2) The temperature profile at the top surface of the parts is recommended as shown below.
 - 3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature.



			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-197
						Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				

Reference

